

Global Palladium Coated Copper Bonding Wires Market Data Survey Report 2025

https://marketpublishers.com/r/GC0B7B17F10EN.html

Date: November 2017

Pages: 82

Price: US\$ 1,500.00 (Single User License)

ID: GC0B7B17F10EN

Abstracts

SUMMARY

Palladium Coated Copper Bonding wire is the material of making interconnections (ATJ) between an integrated circuit (IC) or other semiconductor device and its packaging during semiconductor device fabrication

The global Palladium Coated Copper Bonding Wires market will reach Volume Million USD in 2017 with CAGR xx% 2018-2025. The main contents of the report including:

Global market size and forecast

Regional market size, production data and export & import

Key manufacturers (manufacturing sites, capacity and production, product specifications etc.)

Average market price by SUK

Major applications

Key manufacturers are included based on manufacturing sites, capacity and production, product specifications etc.:

Heraeus

Tanaka

Sumitomo Metal Mining

MK Electron



Doublink Solders
Nippon Micrometal
Yantai Zhaojin Kanfort
Tatsuta Electric Wire & Cable
Heesung Metal
Kangqiang Electronics
Shandong Keda Dingxin Electronic Technology
Everyoung Wire
Major applications as follows:
IC
Transistor
Others
Regional market size, production data and export & import:
Asia-Pacific
North America
Europe
South America



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